IPC ASSOCIATION CONN ELECTRONICS INDUS	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This doc level par	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and Mfg Information				
Supplier Info	formation													
Company name*			Company unique ID			Unique ID Authority				Response Date*				
nsemi											2024-05-16			
Contact Name			Title - Contact			Phone - Cont	Phone - Contact*				Email - Contact*			
Product-Env-S	Stewards		Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com			
uthorized Rep	presentative*		Title - Representative			Phone - Repr	Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA	NA				Product-Env-Stewards@onsemi.com			
Requ	uester Item Number	Mfr Item	Number	Mfr Item Name		Effective Dat	te Vers	ion	Manufacturing Site	W	/eight*	UOM	Unit Type	
		NCID9401 High Spe		High Speed Quad C	igh Speed Quad Channel Digital Isolator		2024-05-16 PBB		PBB	423.399		mg	Each	
	ing Process Informa										- I			
5 2			-		STD-020 MSL Rating									
•	te Tin (Sn) - annealed	C	CU Alloy	1		260		C	30	second	s 3			
omments														
	um time at peak temperat													
or more infort	mation regarding material	l composition	please refer t	o page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted substance	s per the definition above except for selected exemp	tions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature Ra	astislav Drska	-En								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
DBC	54.376	mg	Supplier	Silver (Ag)	7440-22-4		0.0816	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		38.7918	mg
			В	Nickel (Ni)	7440-02-0		0.1305	mg
			Supplier	Copper (Cu)	7440-50-8		15.3721	mg
Die	2.997	mg	Supplier	Silicon (Si)	7440-21-3		2.997	mg
Epoxy	0.036	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		0.0029	mg
			Supplier	Proprietary	Proprietary Data		0.0032	mg
			Supplier	Bismaleimide	13676-54-5		0.0097	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.0004	mg
			Supplier	PTFE	9002-84-0		0.0198	mg
Lead Frame	65.486	mg	Supplier	Silver (Ag)	7440-22-4		0.1965	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1244	mg
			Supplier	Iron (Fe)	7439-89-6		1.6961	mg
			Supplier	Copper (Cu)	7440-50-8		63.3773	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0917	mg
Mold Compound-Black	296.395	mg		Epoxy resin	proprietary data		17.7837	mg
			Supplier	Phenolic Resin	Proprietary Data		17.7837	mg
			Supplier	Carbon Black (C)	1333-86-4		1.482	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		251.9357	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		7.4099	mg
Plating	3.143	mg	Supplier	Tin (Sn)	7440-31-5		3.143	mg
Solder Paste	0.595	mg	Supplier	Silver (Ag)	7440-22-4		0.0149	mg
			A	Lead (Pb)	7439-92-1	7a	0.5504	mg
			Supplier	Tin (Sn)	7440-31-5		0.0298	mg
Wire Bond - Au	0.371	mg	Supplier	Gold (Au)	7440-57-5		0.371	mg